L Number	Hits	Search Text	DB	Time stamp
1	2229	(SiC SiOC SiCO (silicon adj (oxycarbide carbide))) near10	USPAT;	2002/10/11 09:32
		(cu or copper)	US-PGPUB;	
			EPO; JPO;	1
			DERWENT;	
			IBM_TDB	
8	321	((SiC SiOC SiCO (silicon adj (oxycarbide carbide))) near10	USPAT;	2002/10/11 08:14
		(cu or copper)) and (438/\$.ccls. 257/\$.ccls.)	US-PGPUB;	
]			EPO; JPO;	
i l			DERWENT;	
			IBM_TDB	
15	151936	(reduc\$3 react\$3 remov\$3) near4 (oxide CuO)	USPAT;	2002/10/11 08:16
<u> </u>			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
22	50	(((SiC SiOC SiCO (silicon adj (oxycarbide carbide))) near10	USPAT;	2002/10/11 09:04
		(cu or copper)) and (438/\$.ccls. 257/\$.ccls.)) and ((reduc\$3	US-PGPUB;	
		react\$3 remov\$3) near4 (oxide CuO))	EPO; JPO;	i
			DERWENT;	
			IBM_TDB	
29	1	(ibm or (international adj business adj machine\$1)).asn. and	USPAT;	2002/10/11 09:05
		(ALD or ALE or ALCVD or AL-CVD) and nitrates	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
		'	IBM_TDB	
57	4	((SiC SiOC SiCO (silicon adj (oxycarbide carbide))) near10	USPAT;	2002/10/11 09:34
		(cu or copper)) and ((SiOC SiCO (silicon adj oxycarbide))	US-PGPUB;	
		near10 (stop stopper barrier cap capping difussion diffusion))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
50	45	(SiOC SiCO (silicon adj oxycarbide)) near10 (stop stopper	USPAT;	2002/10/11 09:35
		barrier cap capping difussion diffusion)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

```
SYSTEM:OS - DIALOG Or search
File 2:INSPEC 196
                          002/Oct W1
          (c) 2002 Institution of Electrical Engineers
         2: Alert feature enhanced for multiple files, duplicates
 *File
 removal, customized scheduling. See HELP ALERT.
          8:Ei Compendex(R) 1970-2002/Sep W5
          (c) 2002 Engineering Info. Inc.
         8: Alert feature enhanced for multiple files, duplicates
 *File
 removal, customized scheduling. See HELP ALERT.
   File 94:JICST-EPlus 1985-2002/Aug W2
          (c) 2002 Japan Science and Tech Corp(JST)
   File 144: Pascal 1973-2002/Oct W1
          (c) 2002 INIST/CNRS
       Set Items Description
 Processing
           425867 REMOV?
          1981251 REDUC?
            38375 CUO
              561 CU20
           426446 CU
          5869601
                  2
          1323207
                  0
            12549 CU(2W)2(2W)O
           426446 CU
           608773 OXIDE
             3538 CU(3N)OXIDE
          1204119 ORGANIC
           326275 ALCOHOL
            43820 ALDEHYDE
           269103 CARBOXYLIC
                  (REMOV? OR REDUC?) (5N) (CUO OR CU2O OR CU(2W)2(2W)O OR
       S1
                   CU(3N)OXIDE)(10N)(ORGANIC OR ALCOHOL OR ALDEHYDE OR
 ...completed examining records
       S2
               11 RD (unique items)
 ?t s2/full/all
            (Item 1 from file: 2)
  2/9/1
 DIALOG(R) File 2: INSPEC
 (c) 2002 Institution of Electrical Engineers. All rts. reserv.
           INSPEC Abstract Number: A2002-07-8245-011
   Title: The electrochemical quartz Crystal microbalance as a means for
 studying the reactivity of Cu/sub 2/0 toward lithium
   Author(s): Laik, B.; Poizot, P.; Tarascon, J.-M.
   Author Affiliation: Lab. de Reactivite et de Chimie des Solides, Univ. de
 Picardie Jules Verne, Amiens, France
   Journal: Journal of the Electrochemical Society
                                                        vol.149, no.3
 A251-5
   Publisher: Electrochem. Soc,
   Publication Date: March 2002 Country of Publication: USA
   CODEN: JESOAN ISSN: 0013-4651
   SICI: 0013-4651(200203)149:3L.a251:EQCM;1-#
   Material Identity Number: J010-2002-002
   U.S. Copyright Clearance Center Code: 0013-4651/2002/149(3)/251/5/$7.00
   Document Number: S0013-4651(02)01603-8
   Language: English
                       Document Type: Journal Paper (JP)
   Treatment: Applications (A)
   Abstract: Transition-metal oxides (M/sub x/O/sub y/ where M is Co, Ni,
 Cu, or Fe) were recently reported to reversibly react with Li through a
· mechanism that differs from the classical Li insertion/deinsertion or
 Li-alloying ones. We report on the peculiar electrochemical reactivity of
 copper oxide (Cu/sub 2/0) toward lithium, as deduced from the use of an
                   quartz crystal microbalance (EQCM).
                                                              First,
 electrochemical
```

electrodeposition parameters (current, pH, temperature, ...) to prepare single-phase, homogeness, and weight-controlled Cu/s 2/0 deposits on a Ti-plated quartz crystal are reported. Then, an electrochemical cell using the Cu/sub 2/0 deposit as the positive electrode and Li as the negative electrode was cycled over the 3-0.02 V range, and the Cu/sub 2/0 weight evolution was monitored. We show that the weight vs. the number of reacted Li/sup +/ curve does not change smoothly, but exhibits different sloping weight regimes that were broadly linked to the different electrochemical ${\tt Cu}$ /sub 2 / ${\tt O}$ into Cu plus growth of an processes (reduction of organic layer) already mentioned. Therefore, we show that these processes do not occur separately but in conjunction, highlighting the positive attributes of the EQCM technique. (23 Refs) Subfile: A Descriptors: chemical reactions; copper compounds; crystal resonators; electrochemical electrodes; electrochemistry; lithium; microbalances; pH; secondary cells Identifiers: electrochemical quartz crystal microbalance; reactivity; Li; mechanism; electrochemical reactivity; electrodeposition parameters; reduction; current; pH; temperature; Ti-plated quartz crystal; electrochemical cell; positive electrode; negative electrode; Cu/sub 2/0 weight evolution; 3 to 0.02 V; Cu/sub 2/0; SiO/sub 2/:Ti Class Codes: A8245 (Electrochemistry and electrophoresis); A8630F (Secondary cells) Chemical Indexing: Cu20 bin - Cu2 bin - Cu bin - O bin (Elements - 2) SiO2:Ti sur - SiO2 sur - O2 sur - Si sur - Ti sur - O sur - SiO2:Ti ss -SiO2 ss - O2 ss - Si ss - Ti ss - O ss - SiO2 bin - O2 bin - Si bin - O bin - Ti el - Ti dop (Elements - 2,1,3) Li el (Elements - 1) Numerical Indexing: voltage 2.0E-02 to 3.0E+00 V Copyright 2002, IEE 2/9/2 (Item 2 from file: 2) DIALOG(R)File 2:INSPEC (c) 2002 Institution of Electrical Engineers. All rts. reserv. INSPEC Abstract Number: B1999-12-2550F-052 Title: Electrochemical, contact angle, and spectroscopic characterization of metal films during copper damascene processing Author(s): Carpio, R.A.; Hymes, S.; Mikkola, R.; Pavlov, M. Author Affiliation: SEMATECH, Austin, TX, USA Conference Title: Proceedings of the Symposia on Electrochemical Processing in ULSI Fabrication I and Interconnect and Contact p.206-20 Metallization: Materials, Processes, and Reliability Editor(s): Andricacos, P.C.; Dukovic, J.O.; Mathad, G.S.; Oleszek, G.M.; Rathore, H.S.; Reidsema Simpson, C. Publisher: Electrochem. Soc, Pennington, NJ, USA Publication Date: 1999 Country of Publication: USA viii+274 ISBN: 1 56677 200 1 Material Identity Number: XX-1999-01999 viii+274 pp. e Title: Proceedings of the Symposia on Electrochemical in ULSI Fabrication I and Interconnect and Contact Conference Processing Metallization: Materials, Processes, and Reliability Conference Date: 4-5 May 1998 & 1-6 Nov. 1998 Conference Location: San Diego, CA, USA & Boston, MA, USA Document Type: Conference Paper (PA) Language: English Treatment: Practical (P); Experimental (X) Abstract: Localized cathodic chronopotentiometric measurements were utilized to determine the thickness and type of oxide as well as for detection of the presence of reducible organic films on copper surfaces. It was found that Cu /sub 2 / O is the principal oxide formed by CMP using hydrogen peroxide based slurries. The oxide thickness is generally in the 20 to 30 AA range after CMP, but this thickness is reduced approximately half by a typical brush cleaning process. Anodic chronopotentiometry was utilized for Cu thickness measurements. Other DC and AC electrochemical measurements were performed to characterize the

corrosion properties of processed copper and barrier metal film surfaces.

The corrosion properties of copper were dependent upon the electrolyte utilized for the me rements. Sessile contact and measurements were valuable for studying the spatial variation of the wetting properties of processed copper films. FTIR spectroscopy is shown to have the capability for monitoring the Cu/sub 2/O thickness. (13 Refs) Subfile: B Descriptors: chemical interdiffusion; contact angle; copper; corrosion; diffusion barriers; electrochemical analysis; Fourier transform spectra; integrated circuit interconnections; integrated circuit measurement; integrated circuit metallisation; oxidation; process monitoring; wetting Identifiers: spectroscopic characterization; contact angle characterization; electrochemical characterization; metal films; copper damascene processing; localized cathodic chronopotentiometric measurements; oxide type; oxide thickness; reducible organic films; copper surfaces; Cu/sub 2/O principal oxide; CMP; hydrogen peroxide based slurries; brush cleaning process; anodic chronopotentiometry; Cu thickness measurements; AC electrochemical measurements; DC electrochemical measurements; corrosion properties; processed copper film surfaces; barrier metal film surfaces; Cu corrosion properties; measurement electrolyte; sessile contact angle measurements; wetting properties; FTIR spectroscopy; Cu/sub 2/0 thickness monitoring; 20 to 30 angstrom; Cu; Cu/sub 2/0; H/sub 2/0/sub 2/ Class Codes: B2550F (Metallisation and interconnection technology); B2570 (Semiconductor integrated circuits); B2550E (Surface treatment (semiconductor technology)); B2530D (Semiconductor-metal interfaces) Chemical Indexing: Cu sur - Cu el (Elements - 1) Cu2O int - Cu2 int - Cu int - O int - Cu2O bin - Cu2 bin - Cu bin - O bin (Elements - 2) H2O2 bin - H2 bin - O2 bin - H bin - O bin (Elements - 2) Numerical Indexing: size 2.0E-09 to 3.0E-09 m Copyright 1999, IEE (Item 3 from file: 2) 2/9/3 DIALOG(R)File 2:INSPEC (c) 2002 Institution of Electrical Engineers. All rts. reserv INSPEC Abstract Number: A1999-13-6855-105 6264672 Title: Copper-oxide thin films prepared from Langmuir-Blodgett films Author(s): Schurr, M.; Seidl, M.; Brugge, A.; Voit, H. Author Affiliation: Phys. Inst., Erlangen-Nurnberg Univ., Germany Journal: Thin Solid Films p.266-9 vol.342, no.1-2 Publisher: Elsevier, Publication Date: 26 March 1999 Country of Publication: Switzerland CODEN: THSFAP ISSN: 0040-6090 SICI: 0040-6090(19990326)342:1/2L.266:COTF;1-P Material Identity Number: T070-1999-011 Document Number: S0040-6090(98)01448-5 Language: English Document Type: Journal Paper (JP) Treatment: Experimental (X) Abstract: Ultrathin films of CuO have been prepared using an organic precursor (Langmuir-Blodgett multilayer films consisting of Cu-arachidate). removed either by thermodesorption or by component was organic UV-desorption.

Abstract: Ultrathin films of **CuO** have been prepared using an **organic** precursor (Langmuir-Blodgett multilayer films consisting of Cu-arachidate). The **organic** component was **removed** either by thermodesorption or by UV-desorption. In the former case discontinuous films consisting of an ensemble of droplets were obtained. UV-desorption with successive heating results in continuous and rather smooth films. A surface roughness of 2.3 nm was deduced for one of these films from an atomic-force-microscope analysis. The films are transparent in the visible range. (17 Refs) Subfile: A

Descriptors: atomic force microscopy; copper compounds; Langmuir-Blodgett films; photon stimulated desorption; Rutherford backscattering; surface topography; thermally stimulated desorption; thin films; transparency

Identifiers: copper-oxide; ultrathin films; Langmuir-Blodgett multilayer films; Cu-arachidate; organic precursor; thermodesorption; UV-desorption; droplet ensemble; discontinuous films; continuous smooth films; surface roughness; atomic-force-microscope analysis; transparent films; visible spectra; RBS; Rutherford backscattering; elastic recoil detection analysis;

400 to 900 nm; CuO in film growth, structure, and Class Codes: A6855 itaxy); A6817 (Monolayers and Langmuir-Blodgett films); A7755 (Dielectric thin films); A7820D (Optical constants and parameters (condensed matter)); A7865P (Optical properties of other inorganic semiconductors and insulators (thin films/low-dimensional structures)); A7920N (Atom-, molecule-, and ion-surface impact and interactions) Chemical Indexing: CuO bin - Cu bin - O bin (Elements - 2) Numerical Indexing: wavelength 4.0E-07 to 9.0E-07 m Copyright 1999, FIZ Karlsruhe (Item 1 from file: 8) DIALOG(R) File 8:Ei Compendex(R) (c) 2002 Engineering Info. Inc. All rts. reserv. 04131632 E.I. No: EIP95042651943 Title: Effect of PTFE addition on the transfer film, wear and friction of PEEK-CuO composite Author: Voort, J. Vande; Bahadur, S. Corporate Source: Iowa State Univ, Ames, IA, USA Conference Title: Proceedings of the Energy-Sources Technology Conference and Exhibition Conference Location: Houston, TX, USA Conference 19950129-19950201 Sponsor: ASME E.I. Conference No.: 42772 Source: Tribology Symposium 1995 American Society of Mechanical Engineers, Petroleum Division (Publication) PD v 72 1995. ASME, New York, NY, USA. p 169-176 Publication Year: 1995 CODEN: ASMPEX Language: English

Document Type: CA; (Conference Article) Treatment: X; (Experimental)

Journal Announcement: 9506W1

Abstract: In order to **reduce** the coefficient of friction, the **organic** filler was added to the **CuO** -PEEK composite so as to increase its appeal for practical applications. Initially, the optimum volume fraction of CuO in PEEK was determined for minimum wear by varying the proportion of the inorganic filler. With this composition as the basis for total filler content, PTFE was added to CuO-filled composites in 5 and 10 vol.% proportions. It was determined from the experiment that the optimum filler proportion of CuO in PEEK for minimum wear rate was 35 vol.%. The optimum composition with PTFE and Cu additions was PEEK-30 vol.% CuO-5 vol.% PTFE. The wear rate and the coefficient of friction both of these compositions were lower than those of PEEK-35 vol.% CuO. 19 Refs.

Descriptors: *Polytetrafluoroethylenes; Composite materials; Copper oxides; Polyether ether ketones; Addition reactions; Wear of materials; Friction; Films; Fillers; Composition effects

Identifiers: Transfer film; Coefficient of friction; Organic filler; Pin on disk configuration; Wear rate; Steel counterface; Inorganic fillers Classification Codes:

815.1.1 (Organic Polymers)

815.1 (Polymeric Materials); 804.2 (Inorganic Components); 802.2 (Chemical Reactions); 931.1 (Mechanics)

815 (Plastics & Polymeric Materials); 804 (Chemical Products); 802 (Chemical Apparatus & Plants); 421 (Materials Properties); 931 (Applied Physics); 803 (Chemical Agents & Basic Industrial Chemicals)

81 (CHEMICAL PROCESS INDUSTRIES); 80 (CHEMICAL ENGINEERING); 42 (MATERIALS PROPERTIES & TESTING); 93 (ENGINEERING PHYSICS)

2/9/5 (Item 2 from file: 8) DIALOG(R)File 8:Ei Compendex(R) (c) 2002 Engineering Info. Inc. All rts. reserv.

04122342

2342 E.I. No: EIP\$5032641535
Title: Coating of uniform uniform inorganic particles Polyaniline on copper oxide

Author: Huang, Chin-Lin; Partch, Richard E.; Matijevic, Egon

Corporate Source: Clarkson Univ, Potsdam, NY, USA

Source: Journal of Colloid and Interface Science v 170 n 1 Mar 1 1995. 275-283

Publication Year: 1995

CODEN: JCISA5 ISSN: 0021-9797

Language: English

Document Type: JA; (Journal Article) Treatment: X; (Experimental)

Journal Announcement: 9505W5

Abstract: Uniform spherical colloidal copper oxide particles were coated with polyaniline in the reaction mixtures containing CuO, aniline, water, ethanol, and polyvinyl alcohol (PVA) without the use of a soluble oxidant. The final dispersion consisted of a mixture of CuO with a polymer shell and independent polyaniline (latex) particles. The reaction between aniline and Cuo follows the well-known mechanism by which the metal oxide undergoes reductive dissolution while the organic monomer is oxidized. Oxygen and PVA are essential to the polymerization of aniline in the system. Oxygen may function as an oxidant to promote the polymerization, while PVA forms micelles that enhance the reaction rate through emulsion polymerization and protect polyaniline from hydrolysis. A temperature higher than 90 degree C is necessary for the reaction to achieve a coating of more than 10% by weight in 48 h. The thickness of the polymer shell can be adjusted by changing the reaction time and the concentrations of aniline, copper oxide, and ethanol. The structure of the produced polymer corresponds to that of polyleucoemeraldine. (Author abstract) 34 Refs.

Descriptors: *Particles (particulate matter); Colloids; Organic polymers; Oxidation; Polymerization; Monomers; Hydrolysis; Dissolution; Dispersions; Polyvinyl alcohols

Identifiers: Polyaniline; Aniline; Soluble oxidant; Polymer shell; Reductive dissolution; Organic monomer; Reaction rate; Reaction mixtures; Latex particles; Oxidant

Classification Codes:

815.1.1 (Organic Polymers)

804.2 (Inorganic Components); 801.3 (Colloid Chemistry); 815.1 (Polymeric Materials); 802.2 (Chemical Reactions); 815.2 (Polymerization) (Chemical Products); 801 (Chemical Analysis & Physical Chemistry); (Plastics & Polymeric Materials); 802 (Chemical Apparatus & Plants) 80 (CHEMICAL ENGINEERING); 81 (CHEMICAL PROCESS INDUSTRIES)

2/9/6 (Item 3 from file: 8)

DIALOG(R) File 8:Ei Compendex(R)

(c) 2002 Engineering Info. Inc. All rts. reserv.

E.I. Monthly No: EI9210128885 03491507

Title: Selective reduction of nitric oxide over Cu -ZSM-5 zeolite water-soluble oxygen-containing organic compounds.

Author: Montreuil, C. N.; Shelef, M.

Corporate Source: Ford Motor Co, Dearborn, MI, USA

Source: Applied Catalysis B:Environmental v 1 n 1 Feb 19 1992 p L1-L8

Publication Year: 1992

ISSN: 0926-3373 CODEN: ACBEE3

Language: English

Document Type: JA; (Journal Article) Treatment: X; (Experimental)

Journal Announcement: 9210

Abstract: The activity of soluble oxygenated organic compounds for the selective reduction of nitric oxide in the presence of excess oxygen over a highly copper exchanged ZSM-5 zeolite approximates that of propene. The onset of nitric oxide reduction does not require the presence of oxygen and therefore the partially oxygenated reductants are more active when the system is rich with stoichiometry. This observation supports the premise of an oxygenated intermediate when using hydrocarbon reductants. Cu-ZSM-5 does not catalyze the combustion of hydrocarbons or oxygenated organic compounds as cleanly as Cu/ gamma -Al//20//3. 14 Refs.

Descriptors: *NITROGEN OXIDES--*Reduction; CATALYSTS--Zeolites; ZEOLITES --Ion Exchange; HYDROG ONS--Derivatives; OXYGEN--Condition; AIR POLLUTION--Control

Identifiers: SELECTIVE NITRIC OXIDE REDUCTION; OXYGEN-CONTAINING ORGANIC REDUCTANTS; PARTIALLY OXYGENATED REDUCTANTS; COPPER EXCHANGED ZEOLITE CATALYSTS; NITRIC OXIDE REDUCTION CATALYSTS

Classification Codes:

804 (Chemical Products); 802 (Chemical Apparatus & Plants); 803 (Chemical Agents & Basic Industrial Chemicals); 451 (Air Pollution) 80 (CHEMICAL ENGINEERING); 45 (POLLUTION & SANITARY ENGINEERING)

2/9/7 (Item 1 from file: 94)

DIALOG(R) File 94: JICST-EPlus

(c) 2002 Japan Science and Tech Corp(JST). All rts. reserv.

04481014 JICST ACCESSION NUMBER: 00A0076170 FILE SEGMENT: JICST-E

Vacuum Electrical Breakdown Characteristics of Oxygen-free Copper Electrodes Processed Several Kinds of Surface Treatments.

SEKIKAWA KENTARO (1); KOBAYASHI SHIN'ICHI (1); ASANO KIYOMITSU (2); SAITO YOSHIO (3)

(1) Saitama Univ.; (2) Akita Natl. Coll. of Technol.; (3) High Energy Accelerator Research Organization

Denki Gakkai Hoden Kenkyukai Shiryo, 1999, VOL.ED-99,NO.175-182, PAGE.25-30, FIG.8, TBL.2, REF.4

JOURNAL NUMBER: Z0911AAI

UNIVERSAL DECIMAL CLASSIFICATION: 621.3.03/.04

LANGUAGE: Japanese COUNTRY OF PUBLICATION: Japan

DOCUMENT TYPE: Conference Proceeding

ARTICLE TYPE: Original paper MEDIA TYPE: Printed Publication

ABSTRACT: The influence of ozonized water treatment on the conditioning effect of a vacuum gap was investigated by applying impulse voltages. In this study, He ion-beam sputtering was performed to electrodes surfaces treated with ozonized water. The chemical compositions were analyzed by the X-ray Photoelectron Spectroscopy(XPS) before and after the ion-beam sputtering and after the repetitive breakdowns. As a result, sputtered electrodes showed higher breakdown fields than those of electrodes only treated with ozonized water. The results of the XPS narrow-scan spectra confirmed that **organic** contaminants due to Carbon were **removed** and **CuO** films were created on the electrode surfaces by the ozonized water treatment. (author abst.)

DESCRIPTORS: electrode; oxygen free copper; ozonation; ion beam sputtering; oxide film; dielectric strength; dielectric breakdown; vacuum discharge; insulation test; surface treatment

BROADER DESCRIPTORS: copper; 1B group element; transition metal; metallic element; element; fourth row element; treatment; sputtering; conversion coating film; film(cover); membrane and film; resistance(endure); electrical characteristic; characteristic; fracture; gas discharge; electric discharge; test

CLASSIFICATION CODE(S): NA05090R

2/9/8 (Item 1 from file: 144)

DIALOG(R) File 144: Pascal

(c) 2002 INIST/CNRS. All rts. reserv.

15546926 PASCAL No.: 02-0246315

The electrochemical quartz crystal microbalance as a means for studying the reactivity of Cu SUB 2 O toward lithium

LAIK Barbara; POIZOT Philippe; TARASCON Jean-Marie Laboratoire de Reactivite et de Chimie des Solides, Universite de Picardie Jules Verne, 80039 Amiens, France

Journal: Journal of the Electrochemical Society, 2002, 149 (3) A251-A255 ISSN: 0013-4651 CODEN: JESOAN Availability: INIST-4925; 354000100448740060

No. of Refs.: 23 ref.

5-30

Document Type: P (Second); A (Analytic) Country of Publicati United States

Language: English

Transition-metal oxides (M SUB x O SUB y where M is Co, Ni, Cu, or Fe) were recently reported to reversibly react with Li through a mechanism that differs from the classical Li insertion/deinsertion or Li-alloying ones. We report on the peculiar electrochemical reactivity of copper oxide (Cu SUB 2 0) toward lithium, as deduced from the use of an electrochemical quartz microbalance (EQCM). First, the electrodeposition parameters crystal (current, pH, temperature,) to prepare single-phase, homogeneous, and weight-controlled Cu SUB 2 O deposits on a Ti-plated quartz crystal are reported. Then, an electrochemical cell using the Cu SUB 2 O deposit as the positive electrode and Li as the negative electrode was cycled over the 3-0.02 V range, and the Cu SUB 2 O weight evolution was monitored. We show that the weight vs. the number of reacted Li SUP + curve does not change smoothly, but exhibits different sloping weight regimes that were broadly linked to the different electrochemical processes (reduction of Cu SUB into Cu plus growth of an organic layer) already mentioned. Therefore, we show that these processes do not occur separately hut in conjunction, highlighting the positive attributes of the EQCM technique.

English Descriptors: Secondary cell; Organic electrolyte storage battery;
Metal metal oxide batteries; Electric batteries; Electrode material;
Intercalation compound; Lithium ion; Copper oxide; Surface texture;
Surface structure; Chemical reactivity; Quartz microbalance; Potential pH diagram; Electrical characteristic; Discharge charge cycle
Broad Descriptors: Alkali metal Ions; Transition metal Compounds; Metal alcalin Ion; Metal transition Compose; Metal alcalino Ion; Metal transicion Compuesto

French Descriptors: Accumulateur electrochimique; Accumulateur electrolyte organique; Batterie metal oxyde metallique; Batterie electrique; Materiau electrode; Compose insertion; Lithium ion; Cuivre oxyde; Texture surface; Structure surface; Reactivite chimique; Microbalance quartz; Diagramme potentiel pH; Caracteristique electrique; Cycle charge decharge

Classification Codes: 001D05I03E

Copyright (c) 2002 INIST-CNRS. All rights reserved.

2/9/9 (Item 2 from file: 144)

DIALOG(R) File 144: Pascal

(c) 2002 INIST/CNRS. All rts. reserv.

13753622 PASCAL No.: 98-0465338

Preparation of CuO thin films on porous BaTiO SUB 3 by self-assembled/multibilayer film formation and application as a CO SUB 2 sensor

ISHIHARA T; HIGUCHI M; TAKAGI T; ITO M; NISHIGUCHI H; TAKITA Y

Department of Applied Chemistry, Faculty of Engineering, Oita University, Dannoharu 700, Oita 870-1192, Japan; Research and Development Center, Oita University, Dannoharu 700, Oita 870-1192, Japan

Journal: Journal of materials chemistry, 1998, 8 (9) 2037-2042 ISSN: 0959-9428 Availability: INIST-22603; 354000070550320150

No. of Refs.: 18 ref.

Document Type: P (Serial) ; A (Analytic) Country of Publication: United Kingdom

Language: English

Preparation of CuO thin films by decomposition of self-assembled multibilayer films as a molecular template was investigated. Furthermore, the CO SUB 2 sensing property of the resultant CuO thin films on a porous BaTiO SUB 3 was investigated as a capacitive type sensor. Self-assembled bilayer films of a few 1000 layers thickness can be readily obtained by casting an aqueous suspension composed of dimethyldihexadecylammoniun bromide (DC1-16), Cu(CH SUB 3 CO SUB 2) SUB 2 , hexadecylethylenediamine and poly(vinyl alcohol). Divalent copper ions (Cu SUP 2 SUP +) which are

associated with two hexplecylethylenediamine molecules were arranged in the hydrophobic layer of the multibilayer film. Rapid heating to the combustion temperature of DC1-16 was desirable for removing organic molecules in the multibilayer template. Thin films of CuO can be obtained by calcination at temperatures higher than 573 K. The resultant CuO thin films were porous and consisted of fine particles. The capacitance of CuO thin films prepared from self-assembled multibilayer films as a molecular template on the BaTiO SUB 3 porous substrate exhibited a high sensitivity to CO SUB 2, which is twice that of a conventional mixed oxide capacitor of CuO-BaTiO SUB 3. The capacitance of CuO thin films on BaTiO SUB 3 increases with increasing CO SUB 2 concentration in the range from 100 ppm to 50% at 873 K. Consequently, it is concluded that CuO thin films on BaTiO SUB 3 were appropriate capacitive type CO SUB 2 sensors.

English Descriptors: Experimental study; Thin films; Chemical preparation; Gas sensors; Copper oxides; Binary compounds; Porous materials; Self assembly; Bilayers; Multilayers; Carbon dioxide; Suspensions; Heat treatments; Capacitance

Broad Descriptors: Inorganic compounds; Transition element compounds; Organic compounds; Compose mineral; Metal transition compose; Compose organique

French Descriptors: Etude experimentale; Couche mince; Preparation chimique; Capteur de gaz; Cuivre oxyde; Compose binaire; Materiau poreux; Autoassemblage; Bicouche; Multicouche; Carbone dioxyde; Suspension; Traitement thermique; Capacite electrique; 8115T; CuO; Cu O; Substrat BaTiO SUB 3 poreux

Classification Codes: 001B80A15T; 001C04A

Copyright (c) 1998 INIST-CNRS. All rights reserved.

2/9/10 (Item 3 from file: 144)

DIALOG(R) File 144: Pascal

(c) 2002 INIST/CNRS. All rts. reserv.

12004844 PASCAL No.: 95-0193245

Coating of uniform inorganic particles with polymers. II: Polyaniline on copper oxide

CHIN-LIN HUANG; PARTCH R E; MATIJEVIC E

Clarkson univ., cent. advanced materials processing, Potsdam NY 13699-5814, USA

Journal: Journal of colloid and interface science, 1995, 170 (1) 275-283 ISSN: 0021-9797 CODEN: JCISA5 Availability: INIST-4124; 354000059597970360

No. of Refs.: 34 ref.

Document Type: P (Serial) ; A (Analytic)

Country of Publication: USA

Language: English

Uniform spherical colloidal copper oxide particles were coated with polyaniline in the reaction mixtures containing CuO, aniline, water, ethanol, and polyvinyl alcohol (PVA) without the use of a soluble oxidant. The final dispersion consisted of a mixture of CuO with a polymer shell and independent polyaniline (latex) particles. The reaction between aniline and CuO follows the well-known mechanism by which the metal oxide undergoes reductive dissolution while the organic monomer is oxidized. Oxygen and PVA are essential to the polymerization of aniline in the system. Oxygen may function as an oxidant to promote the polymerization, while PVA forms micelles that enhance the reaction rate through emulsion polymerization and protect polyaniline from hydrolysis. A temperature higher than 90 SUP o C is necessary for the reaction to achieve a coating of more than 10% by weight in 48 h. The thickness of the polymer shell can be adjusted by changing the reaction time and the concentrations of aniline, copper oxide, and ethanol. The structure of the produced polymer corresponds to that of polyleucoemeraldine

English Descriptors: Exprimental study; Liquid solid adsorption; Inorganic adsorbent; Copper ox SUB; Organic adsorbate; Anilia bolymer-SEC; Polyvinylalcohol-SEC; Transmission electron microscopy; Colloid particle; Latex; Infrared spectrometry; Thermogravimetry

Broad Descriptors: Transition metal Compounds; Metal transition Compose; Metal transicion Compuesto

French Descriptors: Etude experimentale; Adsorption liquide solide; Adsorbant mineral; Cuivre oxyde-SUB; Adsorbat organique; Aniline polymere-SEC; Vinylique alcool polymere-SEC; Microscopie electronique transmission; Particule colloidale; Latex; Spectrometrie IR; Thermogravimetrie

Classification Codes: 001D09D04H

2/9/11 (Item 4 from file: 144)

DIALOG(R) File 144: Pascal

(c) 2002 INIST/CNRS. All rts. reserv.

10769930 PASCAL No.: 93-0279283

Oxidation, reduction, and isomerization of allyl alcohol and 1-propanol over Cu SUB 2 0 (100)

SCHULZ K H; COX D F

State univ., Virginia polytech. inst., dep. chemical eng., Blacksburg VA 24061, USA

Journal: Journal of physical chemistry: (1952), 1993, 97 (3) 647-655 ISSN: 0022-3654 CODEN: JPCHAX Availability: INIST-549; 354000038376230190

No. of Refs.: 28 ref.

Document Type: P (Serial) ; A (Analytic)

Country of Publication: USA

Language: English

The reactivity of allyl alcohol and 1-propanol has been studied with TDS and XPS on the polar, Cu SUP + -terminated, Cu SUB 2 O(100) surface. Allyl alcohol reacts on the (100) surface to give selective and nonselective oxidation products (acrolein, CO, CO SUB 2 , H SUB 2 O), an isomerization product (propionaldehyde), and a reduction product (propene). 1-Propanol also reacts on the (100) surface to give selective and nonselective oxidation products (acrolein, propionaldebyde, CO, CO SUB 2 , H SUB 2 O) and a reduction product (propene). Both alcohols dissociatively adsorb to form alkoxides